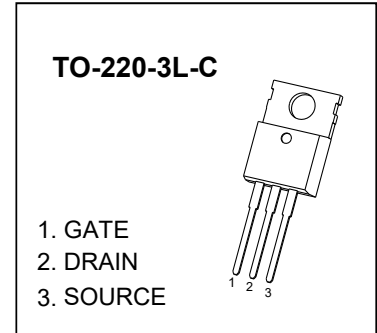




**TO-220-3L-C Plastic-Encapsulate MOSFETS**

**CJP50P06S P-Channel Power MOSFET**

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-60V	25mΩ@-10V	-50A



**GENERAL DESCRIPTION**

The CJP50P06S uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.

**FEATURE**

- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

**APPLICATION**

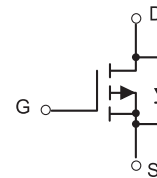
- Power management in notebook computer
- Portable equipment and battery powered systems

**MARKING**



P50P06S = Device code  
 Solid dot = Green molding compound device,  
 if none, the normal device  
 XXXX = Code

**EQUIVALENT CIRCUIT**



**MAXIMUM RATINGS (  $T_a=25^{\circ}C$  unless otherwise noted )**

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	-60	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current	$I_D$ ①	-50	A
Pulsed Drain Current	$I_{DM}$ ②	-200	A
Single Pulsed Avalanche Energy	$E_{AS}$ ③	160	mJ
Power Dissipation	$P_D$ ①	95	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑥	62.5	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	1.31	°C/W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150	°C

# MOSFET ELECTRICAL CHARACTERISTICS

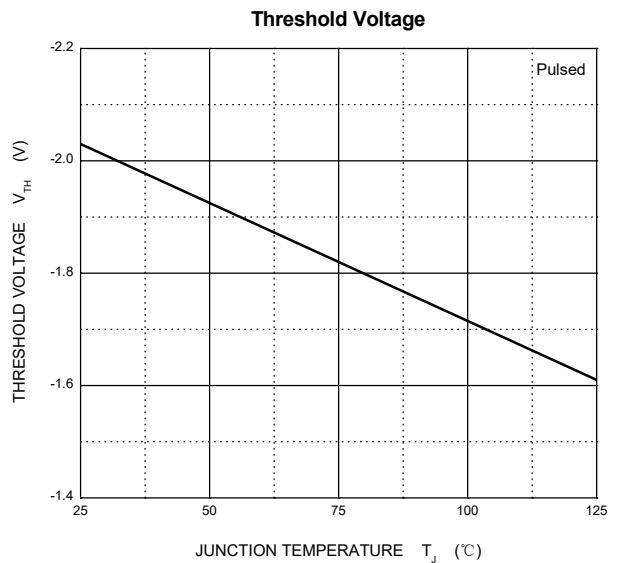
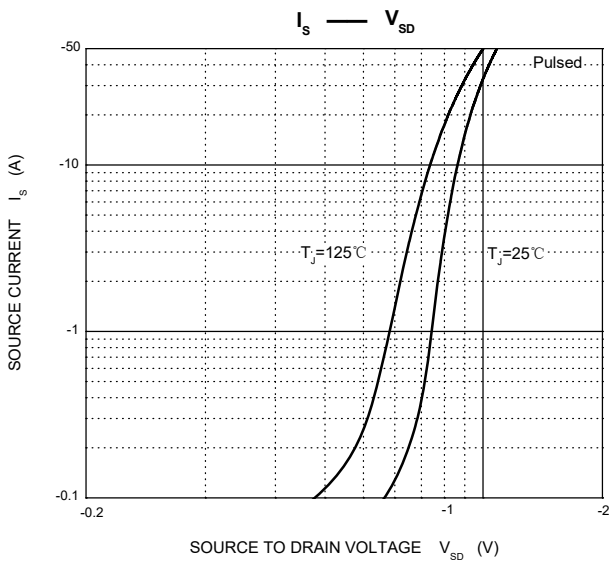
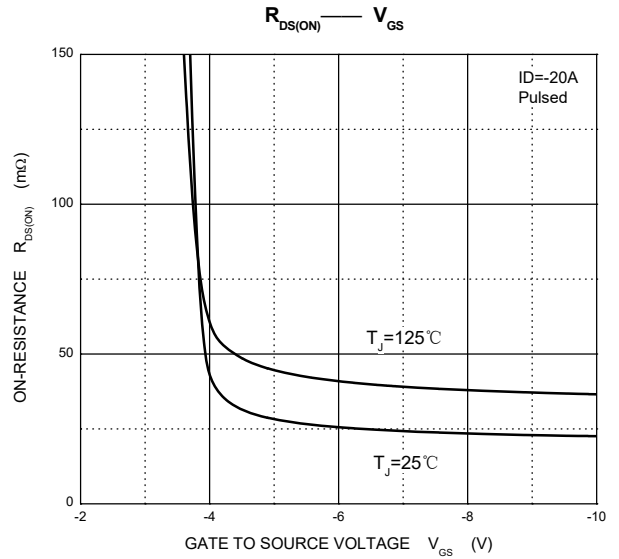
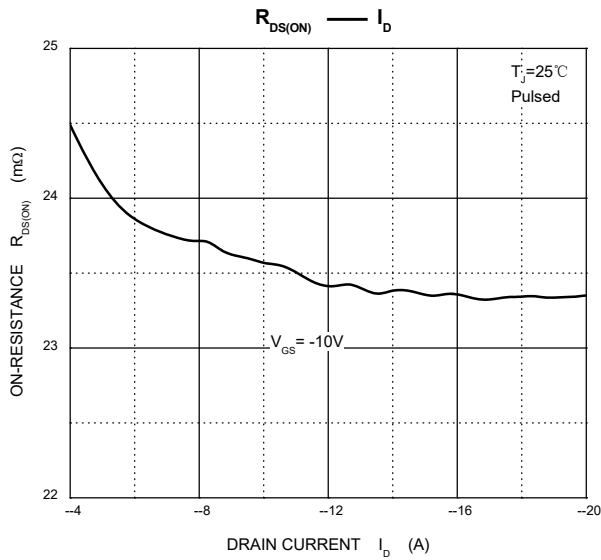
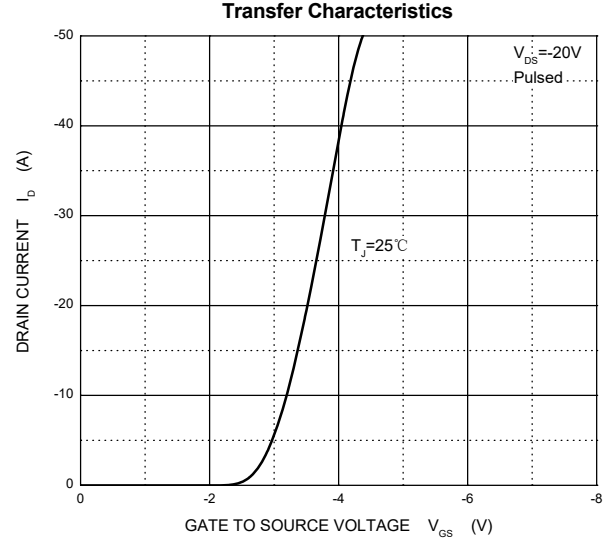
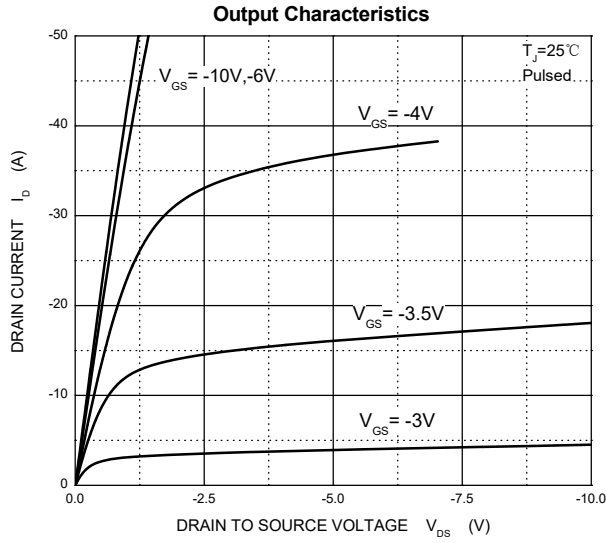
$T_a=25\text{ }^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-60			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -48V, V_{GS} = 0V$	$T_J = 25\text{ }^\circ\text{C}$		1.0	$\mu A$
			$T_J = 125\text{ }^\circ\text{C}$		100	
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
<b>On characteristics</b> <sup>④</sup>						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1.0	-2.0	-3.0	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -20A$		25	35	m $\Omega$
<b>Dynamic characteristics</b> <sup>⑤</sup>						
Input capacitance	$C_{iss}$	$V_{DS} = -25V, V_{GS} = 0V, f = 1MHz$		3005		pF
Output capacitance	$C_{oss}$			184		
Reverse transfer capacitance	$C_{rss}$			167		
Gate resistance	$R_g$	$f = 1MHz$		4.0		$\Omega$
<b>Switching characteristics</b> <sup>⑤</sup>						
Total gate charge	$Q_g$	$V_{GS} = -10V, V_{DS} = -30V, I_D = -20A$		72		nC
Gate-source charge	$Q_{gs}$			15		
Gate-drain charge	$Q_{gd}$			17		
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -30V, R_G = 3\Omega, R_L = 1.5\Omega, V_{GS} = -10V$		16		ns
Turn-on rise time	$t_r$			18		
Turn-off delay time	$t_{d(off)}$			39		
Turn-off fall time	$t_f$			44		
<b>Drain-Source Diode Characteristics</b>						
Drain-source diode forward voltage	$V_{SD}$ <sup>④</sup>	$V_{GS} = 0V, I_S = -20A$			-1.2	V
Continuous drain-source diode forward current	$I_S$ <sup>①</sup>				-50	A
Pulsed drain-source diode forward current	$I_{SM}$ <sup>②</sup>				-200	A

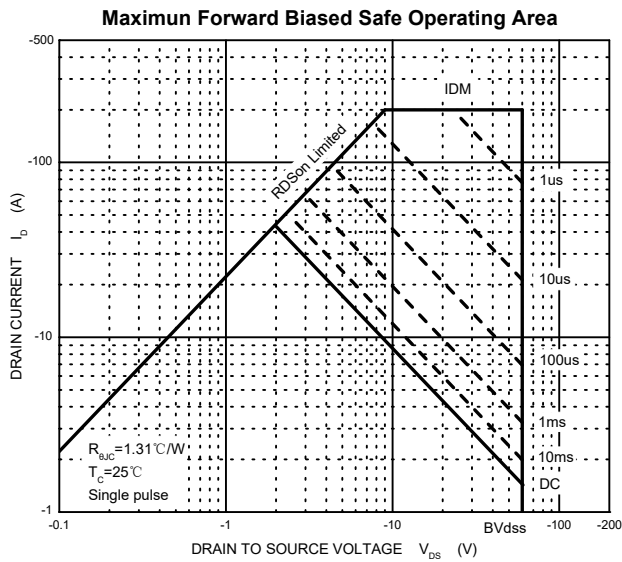
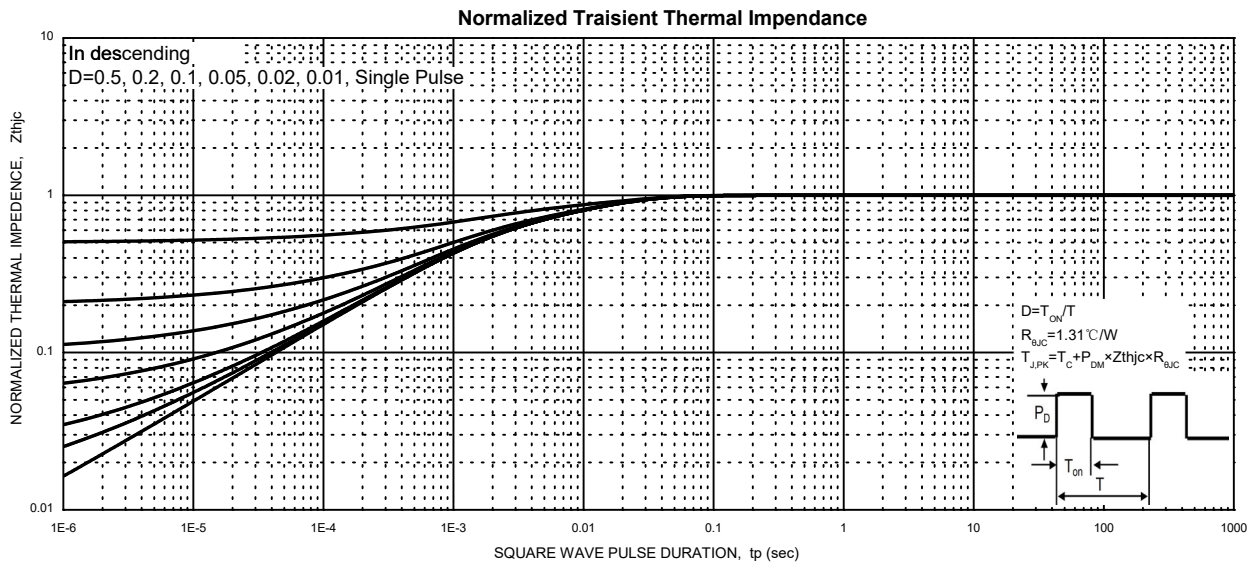
Notes:

- $T_C = 25\text{ }^\circ\text{C}$  Limited only by maximum temperature allowed.
- $P_W \leq 10\mu s$ , Duty cycle  $\leq 1\%$ .
- EAS condition:  $V_{DD} = -25V, V_{GS} = -10V, L = 0.5mH, R_g = 25\Omega$  Starting  $T_J = 25\text{ }^\circ\text{C}$ .
- Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
- Guaranteed by design, not subject to production.
- The value of  $R_{\theta JA}$  is measured with the device in a still air environment with  $T_a = 25\text{ }^\circ\text{C}$ .

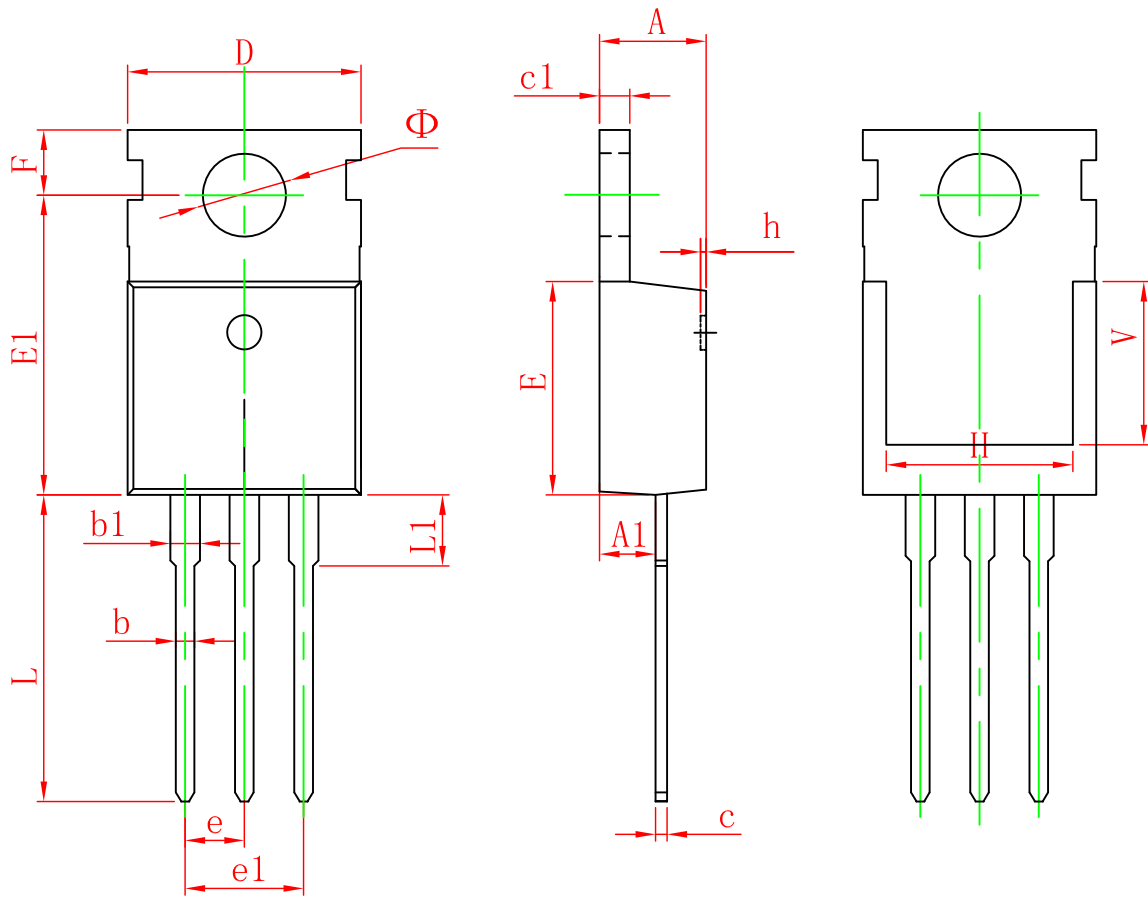
# Typical Characteristics



# Typical Characteristics



# TO-220-3L-C Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
$\Phi$	3.400	3.800	0.134	0.150